

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6665882

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KARTHIK JAMBUNATHAN	07/12/2017
CORY C. BOMBERGER	07/12/2017
GLENN A. GLASS	07/12/2017
ANAND S. MURTHY	07/12/2017
JU H. NAM	07/12/2017
TAHIR GHANI	07/19/2012
RECEIVING PARTY DATA	
Name:	Intel Corporation
Street Address:	2200 Mission College Boulevard
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16611920
CORRESPONDENCE DATA	
Fax Number:	(503)796-2900
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(503) 222-9981
Email:	lpuccinelli@schwabe.com
Correspondent Name:	JUSTIN K. BRASK
Address Line 1:	1211 SW 5TH AVENUE, STE. 1600
Address Line 4:	PORTLAND, OREGON 97204
ATTORNEY DOCKET NUMBER:	P116503PCT-US
NAME OF SUBMITTER:	JUSTIN K. BRASK
SIGNATURE:	/Justin K. Brask/
DATE SIGNED:	04/20/2021
Total Attachments: 2	

source=P116503PCT_ASSIGNMENT_63017--1615921343.647#page1.tif

source=P116503PCT_ASSIGNMENT_63017--1615921343.647#page2.tif

P116503PCT
6/30/17

Attorney Docket No.: P116503PCT

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

KARTHIK JAMBUNATHAN, CORY C. BOMBERGER, GLENN A. GLASS, ANAND S. MURTHY, JU H. NAM AND TAHIR GHANI

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SILICON SUBSTRATE MODIFICATION TO ENABLE FORMATION OF THIN, RELAXED, GERMANIUM-BASED LAYER

which was filed on June 30, 2017 as

International Application Number PCT/US17/40320 and
COUNTRY or International Office

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and

maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

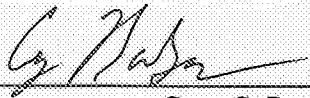
covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Karthik Jambunathan

July 12, 2017

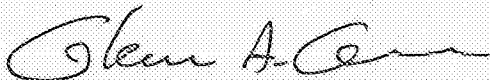
Date signed



Cory C. Bomberger

7/12/2017

Date signed



Glenn A. Glass

7-12-17

Date signed



Anand S. Murthy

7/12/17

Date signed



Ju H. Nam

7/12/17

Date signed



Tahir Ghani

7/19/17

Date signed